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PCI EXPRESS GEN 2 PACKET SWITCH

3-Port, 4-Lane, SlimPacket PCIe 2.0 Packet Switch

DATASHEET REVISION 2-2 September 2017



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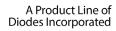
REVISION HISTORY

Date	Revision Number	Description
06/09/10	0.1	Preliminary Datasheet
10/21/10	0.2	Added Section 6 EEPROM Interface And System Management Bus
		Added Section 7 Register Description
07/12/11	0.3	Added Industrial Temperature Support (Section 1 Features, Section 11.1 Absolute
		Maximum Ratings, Section 13 Ordering Information)
11/23/11	0.4	Updated Section 1 Features (integrated reference clock)
11,23,11		Updated Section 3.1 PCI Express Interface Signals (Added REFCLKI P, REFCLKI N,
		REFCLKO_P[2:0], REFCLKO_N[2:0], and IREF)
07/25/12	1.0	Updated Section 1 Features (OBFF and LTR support)
07723712	1.0	Updated Section 3 Pin Description (RXPOLINV_DIS, PRSNT[3:1], TEST4, TEST5, and
		CVDDR)
		Updated Section 6 EEPROM Interface And System Management Bus
		Updated Section 7 Register Description
01/02/13	1.1	Updated Section 3 Pin Description (PWR SAV, TCK, and TRST L)
01/02/13	1.1	Added Section 11.4 AC Switching Characteristics of Clock Buffer
		Updated Table 8-1 Clock Requirement
		Updated Table 3.5 Power Pins
		Updated Table 4.1 Pin List of 129-Pin LQFP
07/15/14	1.2	Updated Section 1 (512-byte maximum payload size support, No-blocking capability)
0//13/17	1,2	Updated Section 3.2 Port Configuration Signals
		Updated Section 3.3 Miscellaneous Signals
		Updated Section 4.1 Pin List of 129-Pin LQFP
		Updated Section 5.1 Physical Layer Circuit
		Updated Section 5.1.7 Drive De-Emphasis
		Updated Section 7.2.75 Device Capabilities Register (Max_Payload_Size Supported)
		Updated Section 13 Ordering Information
		Updated Table 11-2 DC Electrical Characteristics
11/17/14	1.3	Updated Section 7.2 Transparent Mode Configuration Registers
11/1//11	1.5	Updated Section 8 Clock Scheme
07/16/15	1.4	Updated Section 3.1 PCI Express Interface Signals
		Updated Section 3.2 Port Configuration Signals
		Updated Section 5.1 Physical Layer Circuit
		Updated Section 6.1 EEPROM Interface
		Updated Section 7.2 Transparent Mode Configuration Registers
		Updated Section 8 Clock Scheme
		Updated Table 9-1 Instruction Register Codes
		Updated Table 9-2 JTAG Device ID Register
		Updated Table 9-3 JTAG Boundary Scan Register Definition
		Updated Table 11-2 DC Electrical Characteristics
09/07/15	1.5	Updated Table 11-1 Absolute Maximum Ratings
12/23/15	1.6	Updated Section 3.1 PIN Description
	1	Updated the Table 11-1 Absolute Maximum Ratings
		Updated the Table 11-2 DC Electrical Characteristics
03/04/16	1.7	Added Section 11 Power Sequence
		Updated Section 4.1 PIN LIST of 129-PIN LQFP
09/05/17	2-2	Updated Section 1 Features
07/03/17		Updated Section 3.2 Port Configuration Signals
	1	Updated Section 5.1 Physical Layer Circuit
	1	Updated Section 6.1.4 Mapping EEPROM Contents to Configuration Registers
		Updated Section 7.2 Transparent Mode Configuration Registers
		Updated Section 12.1 Absolute Maximum Ratings
		Updated Table 12-2 DC Electrical Characteristics
		Added Section 12.4 Operating Ambient Temperature
		Added Section 12.4 Operating Ambient Temperature Added Section 12.5 Power Consumption
	1	Revision numbering system changed to whole number
1		Revision numbering systementanged to whole number



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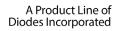
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PI7C9X2G304SL

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1 FEATURES

- 4-lane PCI Express Gen 2 Switch with 3 PCI Express ports
- Supports "Cut-through" (Default) as well as "Store and Forward" mode for packet switching
- Peer-to-peer switching between any two downstream ports
- 150 ns typical latency for packet routed through Switch without blocking
- Integrated reference clock for downstream ports
- Strapped pins configurable with optional EEPROM or SMBus
- SMBus interface support
- Compliant with System Management (SM) Bus, Version 1.0
- Compliant with PCI Express Base Specification Revision 2.1
- Compliant with PCI Express CEM Specification Revision 2.0
- Compliant with PCI-to-PCI Bridge Architecture Specification Revision 1.2
- Compliant with Advanced Configuration Power Interface (ACPI) Specification
- Reliability, Availability and Serviceability
 - Supports Data Poisoning and End-to-End CRC
 - Advanced Error Reporting and Logging
 - IEEE 1149.1 JTAG interface support
- Advanced Power Saving
 - Empty downstream ports are set to idle state to minimize power consumption
- Link Power Management
 - Supports L0, L0s, L1, L2, L2/L3_{Ready} and L3 link power states
 - Active state power management for L0s and L1 states
- Device State Power Management
 - Supports D0, D3_{Hot} and D3_{Cold} device power states
 - 3.3V Aux Power support in D3_{Cold} power state
- Port Arbitration: Round Robin (RR), Weighted RR and Time-based Weighted RR
- Extended Virtual Channel capability
 - Two Virtual Channels (VC) and Eight Traffic Class (TC) support
 - Disabled VCs' buffer is assigned to enabled VCs for resource sharing
 - Independent TC/VC mapping for each port
 - Provides VC arbitration selections: Strict Priority, Round Robin (RR) and Programmable Weighted RR
- Supports Isochronous Traffic
 - Isochronous traffic class mapped to VC1 only
 - Strict time based credit policing
- Supports up to 512-byte maximum payload size
- Programmable driver current and de-emphasis level at each individual port
- Support Access Control Service (ACS) for peer-to-peer traffic
- Support Address Translation (AT) packet for SR-IOV application
- Support OBFF and LTR
- Low Power Dissipation: 650 mW typical in L0 normal mode
- Industrial Temperature Range -40° to 85°C
- 128-pin LQFP 14mm x 14mm package





2 GENERAL DESCRIPTION

Similar to the role of PCI/PCIX Bridge in PCI/PCIX bus architecture, the function of PCI Express (PCIE) Switch is to expand the connectivity to allow more end devices to be reached by host controllers in PCIE serial interconnect architecture. The 4-lane PCIe Switch is in 3-port type configuration. It provides users the flexibility to expand or fan-out the PCI Express lanes based on their application needs.

In the PCI Express Architecture, the PCIE Switch forwards posted and non-posted requests, and completion packets in either downstream or upstream direction concurrently as if a virtual PCI Bridge is in operation on each port. By visualizing the port as a virtual Bridge, the Switch can be logically viewed as two-level cascaded multiple virtual PCI-to-PCI Bridges, where one upstream-port Bridge sits on all downstream-port Bridges. Similar to a PCI Bridge during enumeration, each port is given a unique bus number, device number, and function number by the initiating software. The bus number, device number, and function number are combined to form a destination ID for each specific port. In addition to that, the memory-map and IO address ranges are exclusively allocated to each port as well. After the software enumeration is finished, the packets are routed to the dedicated port based on the embedded address or destination ID. To ensure the packet integrity during forwarding, the Switch is not allowed to split the packets to multiple small packets or merge the received packets into a large transmit packet. Also, the IDs of the requesters and completers are kept unchanged along the path between ingress and egress port.

The Switch employs the architecture of Combined Input and Output Queue (CIOQ) in implementation. The main reason for choosing CIOQ is that the required memory bandwidth of input queue equals to the bandwidth of ingress port rather than increasing proportionally with port numbers as an output queue Switch does. The CIOQ at each ingress port contains separate dedicated queues to store packets. The packets are arbitrated to the egress port based on the PCIe transaction-ordering rule. For the packets without ordering information, they are permitted to pass over each other in case that the addressed egress port is available to accept them. As to the packets required to follow the ordering rule, the Head-Of-Line (HOL) issue becomes unavoidable for packets destined to different egress ports since the operation of producer-consumer model has to be retained; otherwise the system might occur hang-up problem. On the other hand, the Switch places replay buffer at each egress port to defer the packets before sending it out. This can assure the maximum throughput being achieved and therefore the Switch works efficiently. Another advantage of implementing CIOQ in PCIe Switch is that the credit announcement to the counterpart is simplified and streamlined because of the credit-based flow control protocol. The protocol requires that each ingress port maintains the credits independently without checking other ports' credit availability, which is otherwise required by pure output queue architecture.

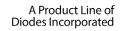
The Switch supports two virtual channels (VC0, VC1) and eight traffic classes (TC0 ~ TC7) at each port.

The ingress port independently assigns packets into the preferred virtual channel while the egress port outputs the packet based on the predefined port and VC arbitration algorithm. For instance, the isochronous packet is given a special traffic class number other than TC0 and mapped into VC1 accordingly. By employing the strict time based credit policy for port arbitration and assigning higher priority to VC1 than VC0, the Switch can therefore guarantee the time-sensitive packet is not blocked by regular traffic to assure the quality of service. In addition, some datacentric applications only carry TC0/VC0 traffic. As a result, there are no packets that would consume VC1 bandwidth. In order to improve the efficiency of buffer usage, the unused VC1 queues can be reassigned to VC0 and enable each of the ingress ports to handle more data traffic bursts. This virtual channel resource relocation feature enhances the performance of the PCIe Switch further.

The Switch provides the advanced feature of Access Control Service (ACS). This feature regulates which components are allowed to communicate with each other within the PCIe multiple-point fabric, and allows the system to have more control over packet routing in the Switch. As a result, peer-to-peer traffic can be facilitated more accurately and efficiently. When the system also implements Address Translation Service (ATS), the peer-to-peer requests with translated address can be routed directly by enabling the corresponding option in ACS to avoid possible performance bottleneck associated with re-direction, which introduces extra latency and may increase link and RC congestion.

The built-in Integrated Reference Clock Buffer of the PCI Express Switch supports three reference clock outputs. The clock buffer is from a single 100MHz clock input, and distributes the clock source to three outputs, which can be







used by the downstream PCI Express end devices. The clock buffer feature can be enabled and disabled by strapping pin setting.





3 PIN DESCRIPTION

3.1 PCI EXPRESS INTERFACE SIGNALS

REFCLKN 110, 111	NAME	PIN	TYPE	DESCRIPTION
when integrated reference clock buffer is disabled (CLKBUF_PD=1), or connect to one of the Integrated Reference Clock Output Pairs; (REFCLKO_P and REFCLKO_N) of this Switch when integrated reference clock buffer is enabled (CLKBUF_PD=0). The input clock signals must be delivered to the clock buffer cell through an AC-coupled interface so that only the AC information of the clock is received, converted, and buffered. It is recommended that a 0.1 uff be used in the AC-coupling. PERP [3:0] 121, 103, 98, 1 127 POT 0 (Upstream Port) Lane 0 is PERP[0] and PERN[0] POT 0 (Upstream Port) Lane 0 is PERP[0] and PERN[0] POT 0 (Upstream Port) Lane 0 is PERP[1] and PERN[1] POT 2 (Downstream Port) is PERP[1] POT 2 (Downstream Port) is PERP[1] POT 2 (Downstream Port) is PERP[1] PO			I	
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connected to a board trace and not driven, it is recommended that an				
external 330-ohm pull-down resistor be used.				connected to a board trace and not driven, it is recommended that an
		<u> </u>		external 330-ohm pull-down resistor be used.



3.2 PORT CONFIGURATION SIGNALS

NAME	PIN	TYPE	DESCRIPTION
VC1_EN	18	I	Virtual Channel 1 Resource Sharing Enable: The chip provides the
			capability to support virtual channel 1 (VC1), in addition to the
			standard virtual channel 0. When this pin is asserted high, Virtual
			Channel 1 is enabled, and virtual channel resource sharing is not
			available. When it is asserted low, the chip would allocate the
			additional VC1 resource to VC0, and VC1 capability is disabled. This
			pin has internal pull-down resistor. If no board trace is connected to
			this pin, the internal pull-down resistor of this pin is enough. However,
			if pin is connected to a board trace and not driven, it is recommended
			that an external 330-ohm pull-down resistor be used.
RXPOLINV_DIS	24	I	Rx Polarity Inversion Disable: When RXPOLINV_DIS is asserted
			high, it indicates to disable Rx Polarity Inversion detection function.
			Otherwise, it indicates to enable Rx Polarity Inversion detection
			function. This pin has internal pull-down resistor. If no board trace is
			connected to this pin, the internal pull-down resistor of this pin is
			enough. However, if pin is connected to a board trace and not driven, it
			is recommended that an external 330-ohm pull-down resistor be used.
PL_512B	53	I	Max. Payload Size 512B: When PL_512B is asserted high, it
			indicates the max. payload size capability is 512B. Otherwise, it
			indicates the max. Payload size is 256B. This pin has internal pull-
			down resistor. If no board trace is connected to this pin, the internal
			pull-down resistor of this pin is enough. However, if pin is connected
			to a board trace and not driven, it is recommended that an external 330-
DDCNITTO 11	20.10		ohm pull-down resistor be used.
PRSNT[2:1]	20, 19	I	Present: When PRSNT is asserted low, it indicates that the device is
			present in the slot of downstream port. Otherwise, it indicates the
			absence of the device. PRSNT[x] is correspondent to Port x, where
CL OT CL IZ	2.2	т	x=1,2. These pins have internal pull-down resistors.
SLOTCLK	33	I	Slot Clock Configuration: It determines if the downstream
			component uses the same physical reference clock that the platform
			provides on the connector. When SLOT CLK is high, the platform
			reference clock is employed. By default, all downstream ports use the same physical reference clock provided by plat form. This pin has
			internal pull-down resistor. If no board trace is connected to this pin,
			the internal pull-down resistor of this pin is enough. However, if pin is
			connected to a board trace and not driven, it is recommended that an
			external 330-ohm pull-down resistor be used.
SLOT IMP[2:1]	46, 45	Ī	Slot Implemented: These signals are asserted to indicate that the
SEO 1_1111 [2.1]	40,43		downstream ports are connected to slots. SLOT IMP[x] corresponds to
			Portx, where x = 1,2. When SLOT_IMP[x] is asserted, the Portx is
			connected to slot. These pins have internal pull-down resistors. If no
			board trace is connected to these pins, the internal pull-down resistors
	1]	of these pins are enough. However, if pins are connected to a board
			trace and not driven, it is recommended that external 330-ohm pull-
			down resistors be used.
PORT ST ATUS[2:0]	69, 68, 67	0	Port Status: These signals indicate the status of each port. Please
[]			connect to pin header for debug used.
			PORT ST ATUS[x] is correspondent to Port x, where $x=0, 1, 2$.
l	1		LJ 1 11 11 11 11 11 17 17 17 17 17 17 17 1

3.3 MISCELLANEOUS SIGNALS

NAME	PIN	TYPE	DESCRIPTION
EECLK	70	O	EEPRO M Clock: Clock signal to the EEPROM interface.
EEPD	71	I/O	EEPRO M Data: Bi-directional serial data interface to and from the
			EEPROM. The pin is set to '1' by default.
SMBCLK	26	I	SM Bus Clock: System management Bus Clock. This pin requires an
			external 5.1K-ohm pull-up resistor.
SMBDATA	27	I/O	SM Bus Data: Bi-Directional System Management Bus Data. This pin
			requires an external 5.1K-ohm pull-up resistor.



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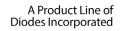
PI7C9X2G304SL

NAME	PIN	TYPE	DESCRIPTION
SCAN_EN	72	I/O	Full-Scan Enable Control: For normal operation, SCAN_EN is an
			output with a value of "0". SCAN_EN becomes an input during
			manufacturing testing.
GPIO[7:0]	44, 43, 42,	I/O	General Purpose Input and Output: These eight general-purpose
	39, 38, 37,		pins are programmed as either input-only or bi-directional pins by
	35, 36		writing the GPIO output enable control register.
			When SMBus is implemented, GPIO[7:5] act as the SMBus address
			pins, which set Bit 2 to 0 of the SMBus address.
			Debug Mode Selection: In debug mode, GPIO[4:0] are used for
			Debug Mode Selection.
PWR_SAV	28	I	Power Saving Mode: PWR SAV is a strapping pin. When this pin is
			pulled high when system is reset, the Power Saving Mode is enabled.
			When this pin is pulled low when system is reset, the Power Saving
			Mode is disabled. When this pin is pulled low, it should be tied to
			ground through a 330-ohm pull-down resistor. When this pin is pulled
			high, a 5.1K-ohm pull-up resistor should be used.
TEST3	17	I	Test3/5/6: These pins are for internal test purpose. Test3, Test5 and
TEST 5	25		Test6 should be tied to ground through a 330-ohm pull-down resistor.
TEST 6 TEST 4	51	т	Total. The min is for internal test manners. It should be tis die amount
1 ESI 4	22	I	Test4: The pin is for internal test purpose. It should be tied to ground
			through a 330-ohm pull-down resistor for normal operation.
			Port Status Output Enable: In debug mode, it is used to enable
			Port Status output.
TEST1	9	I	Test1: The pin is for internal test purpose. It should be tied to 3.3V
			through a 5.1 K-ohm pull-up resistor for normal operation.
			Debug Mode Enable : In debug mode, it need be tired to low through a
			330-ohm pull-down resistor.
TEST2	16	I	Test2: The pin is for internal test purpose. Test2 should be tied to 3.3V
			through a 5.1 K-ohm pull-up resistor.
NC	7, 21, 47, 48,		Not Connected: These pins can be just left open.
	52, 54, 57,		
	58, 59, 75,		
	76, 114		

3.4 JTAG BOUNDARY SCAN SIGNALS

Name	Pin	Type	Description
TCK	89	I	Test Clock: Used to clock state information and data into and out of the chip during boundary scan. When JTAG boundary scan function is not implemented, this pin should be left open (NC).
TMS	92	I	Test Mode Select: Used to control the state of the Test Access Port controller. When JT AG boundary scan function is not implemented, this pin should be pulled low through a 330-Ohm pull-down resistor.
TDO	88	О	Test Data Output: Used (in conjunction with TCK) to shift data out of the Test Access Port (TAP) in a serial bit stream. When JT AG boundary scan function is not implemented, this pin should be left open (NC).
TDI	93	I	Test Data Input: Used (in conjunction with TCK) to shift data and instructions into the TAP in a serial bit stream. When JTAG boundary scan function is not implemented, this pin should be left open (NC).
TRST_L	94	Ī	Test Reset (Active LOW): Active LOW signal to reset the TAP controller into an initialized state. When JTAG boundary scan function is not implemented, this pin should be pulled low through a 330-Ohm pull-down resistor.







3.5 POWER PINS

NAME	PIN	TYPE	DESCRIPTION
VDDC	3, 23, 29, 31,	P	VDDC Supply (1.0V): Used as digital core power pins.
	40, 55, 62, 65,		
	91		
VDDR	1, 8, 49, 64, 96	P	VDDR Supply (3.3V): Used as digital I/O power pins.
CVDDR	79, 82, 84	P	VDDR Supply (3.3V): Used as reference clock power pins.
VDDCAUX	13, 14	P	VDDCAUX Supply (1.0V): Used as auxiliary core power pins.
VAUX	15	P	VAUX Supply (3.3V): Used as auxiliary I/O power pins.
AVDD	99, 105, 108,	P	AVDD Supply (1.0V): Used as PCI Express analog power pins.
	119, 125		
AVDDH	113	P	AVDDH Supply (3.3V): Used as PCI Express analog high voltage
			power pins.
CGND	109, 112	P	Ground: Used as reference clock ground pins.
VSS	2, 4, 11, 12, 30,	P	VSS Ground: Used as ground pins.
	32, 34, 41, 50,		
	56, 61, 63, 66,		
	87, 90, 95, 104,		
	120, 126, 129		





4 PIN ASSIGNMENTS

4.1 PIN LIST of 129-PIN LQFP

PIN	NAME	PIN	NAME	PIN	NAME	PIN	NAME
1	VDDR	33	SLOTCLK	65	VDDC	97	PERP[1]
2	VSS	34	VSS	66	VSS	98	PERN[1]
3	VDDC	35	GPIO[1]	67	PORT ST ATUS[0]	99	AVDD
4	VSS	36	GPIO[0]	68	PORT ST ATUS[1]	100	PETP[1]
5	DWNRST_L[1]	37	GPIO[2]	69	PORT ST ATUS[2]	101	PETN[1]
6	DWNRST_L[2]	38	GPIO[3]	70	EECLK	102	PERP[2]
7	NC	39	GPIO[4]	71	EEPD	103	PERN[2]
8	VDDR	40	VDDC	72	SCAN_EN	104	VSS
9	TEST1	41	VSS	73	REFCLKI_N	105	AVDD
10	PERST_L	42	GPIO[5]	74	REFCLKI_P	106	PETP[2]
11	VSS	43	GPIO[6]	75	NC	107	PETN[2]
12	VSS	44	GPIO[7]	76	NC	108	AVDD
13	VDDCAUX	45	SLOT_IMP[1]	77	REFCLKO_N[2]	109	CGND
14	VDDCAUX	46	SLOT_IMP[2]	78	REFCLKO_P[2]	110	REFCLKP
15	VAUX	47	NC	79	CVDDR	111	REFCLKN
16	TEST2	48	NC	80	REFCLKO_N[1]	112	CGND
17	TEST3	49	VDDR	81	REFCLKO_P[1]	113	AVDDH
18	VC1_EN	50	VSS	82	CVDDR	114	NC
19	PRSNT[1]	51	TEST6	83	REFCLKO_N[0]	115	REXT_GND
20	PRSNT[2]	52	NC	84	CVDDR	116	REXT
21	NC	53	PL_512B	85	REFCLKO_P[0]	117	PETN[3]
22	TEST4	54	NC	86	IREF	118	PETP[3]
23	VDDC	55	VDDC	87	VSS	119	AVDD
24	RXPOLINV_DIS	56	VSS	88	TDO	120	VSS
25	TEST5	57	NC	89	TCK	121	PERN[3]
26	SMBCLK	58	NC	90	VSS	122	PERP[3]
27	SMBDATA	59	NC	91	VDDC	123	PETN[0]
28	PWR_SAV	60	CLKBUF_PD	92	TMS	124	PETP[0]
29	VDDC	61	VSS	93	TDI	125	AVDD
30	VSS	62	VDDC	94	TRST_L	126	VSS
31	VDDC	63	VSS	95	VSS	127	PERN[0]
32	VSS	64	VDDR	96	VDDR	128	PERP[0]
129	E PAD						



5 FUNCTIONAL DESCRIPTION

Multiple virtual PCI-to-PCI Bridges (VPPB), connected by a virtual PCI bus, reside in the Switch. Each VPPB contains the complete PCIe architecture layers that consist of the physical, data link, and transaction layer. The packets entering the Switch via one of VPPBs are first converted from serial bit-stream into parallel bus signals in physical layer, stripped off the link-related header by data link layer, and then relayed up to the transaction layer to extract out the transaction header. According to the address or ID embedded in the transaction header, the entire transaction packets are forwarded to the destination VPPB for formatting as a serial-type PCIe packet through the transmit circuits in the data link layer and physical layer. The following sections describe these function elements for processing PCIe packets within the Switch.

5.1 PHYSICAL LAYER CIRCUIT

The physical layer circuit design is based on the PHY Interface for PCI Express Architecture (PIPE). It contains Physical Media Attachment (PMA) and Physical Coding Sub-layer (PCS) blocks. PMA includes Serializer/Deserializer (SERDES), PLL¹, Clock Recovery module, receiver detection circuits, beacon transmitter, electrical idle detector, and input/output buffers. PCS consists of framer, 8B/10B encoder/decoder, receiver elastic buffer, and PIPE PHY control/status circuitries. To provide the flexibility for port configuration, each lane has its own control and status signals for MAC to access individually. In addition, a pair of PRBS generator and checker is included for PHY built-in self test. The main functions of physical layer circuits include the conversion between serial-link and parallel bus, provision of clock source for the Switch, resolving clock difference in receiver end, and detection of physical layer errors.

In order to meet the needs of different application, the drive amplitude, de-emphasis and equalization of each transmitting channels can be adjusted using EEPROM individually. De-emphasis of -3.5 db is implemented by the transmitters when full swing signaling is used, while an offset can be individually applied to each channel.

5.1.1 RECEIVER DETECTION

The physical layer circuits implement receiver detection, which detects the presence of an attached 50 ohm to ground termination as per PCI Express Specification. The detect circuits determine if the voltage levels of the receiver have crossed the internal threshold after a configurable time determined by the Receiver Detection Threshold field in the PHY Parameter 2 Register (offset 7Ch, bit[6:4]), which can be configured by EEPROM or SMBUS settings.

Table 5-1 Receiver Detection Threshold Settings

Receiver Detection Threshold	Threshold
000	1.0 us
001	2.0 us
010	4.0 us (Recommended)
011	5.0 us
100	10 us
101	20 us
110	40 us
111	50 us

_

¹ Multiple lanes could share the PLL.





5.1.2 RECEIVER SIGNAL DETECTION

Receiver signal idling is detected with levels above a programmable threshold specified by Receiver Signal Detect field in the PHY Parameter 2 Register (Offset 7Ch, bit[21:20]), which can be configured on a per-port basis via EEPROM or SMBUS settings.

Table 5-2 Receiver Signal Detect Threshold

Receiver Signal Detect	Min (mV ppd)	Max (mV ppd)
00	50	80
01 (Recommended)	65	175
10	75	200
11	120	240

5.1.3 RECEIVER EQUALIZATION

The receiver implements programmable equalizer via the Receiver Equalization field in the PHY Parameter 2 Register (Offset 7Ch, bit[25:22]), which can be configured on a per-port basis via EEPROM or SMBUS settings.

Table 5-3 Receiver Equalization Settings

Receiver Equalization	Equalization
0000	Off
0010	Low
0110 (Recommended)	Medium
1110	High

5.1.4 TRANSMITTER SWING

The PCI Express transmitters support implementations of both full voltage swing and half (low) voltage swing. In full swing signaling mode, the transmitters implement de-emphasis, while in half swing mode, the transmitters do not. The Transmitter Swing field in the PHY Parameter 2 Register (offset 7Ch, Bit[30]) is used for the selection of full swing signaling or half swing signaling, which can be configured on a per-port basis via EEPROM or SMBUS settings.

Table 5-4 Transmitter Swing Settings

Transmitter Swing	Mode	De-emphasis
0	Full Voltage Swing	Implemented
1	Half Voltage Swing	Not implemented

5.1.5 DRIVE AMPLITUDE AND DE-EMPHASIS SETTINGS

Depending on the operation condition (voltage swing and de-emphasis condition), one of the Drive Amplitude Base Level fields in the Switch Operation Mode Register (offset 74h) and one of the Drive De-Emphasis Base Level fields in the PHY Parameter 1 Register (offset 7Ah) are active for configuration of the amplitude and de-emphasis.

The final drive amplitude and drive de-emphasis are the summation of the base level value and the offset value. The offset value for drive amplitude is 25 mV pd, and 6.25 mV pd for drive de-emphasis.

The driver output waveform is the synthesis of amplitude and de-emphasis. The driver amplitude without de-emphasis is specified as a peak differential voltage level (mVpd), and the driver de-emphasis modifies the driver amplitude.



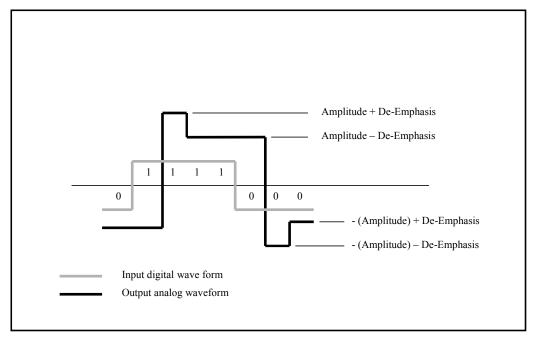


Figure 5-1 Driver Output Waveform

5.1.6 DRIVE AMPLITUDE

Only one of the Drive Amplitude Level field in the Switch Operation Mode Register (offset 74h, bit [20:16], bit [25:21] and bit [30:26]) is active depending on the de-emphasis and swing condition. The settings and the corresponding values of the amplitude level, which can be configured by EEPROM or SMBUS settings.

Table 5-5 Drive Amplitude Base Level Registers

Register	De-Emphasis Condition	Swing Condition
C_DRV_LVL_3P5_NOM	-3.5 db	Full
C_DRV_LVL_6P0_NOM	-6.0 db	Full
C DRV LVL HALF NOM	N/A	Half

Table 5-6 Drive Amplitude Base Level Settings

Setting	Amplitude (mV pd)	Setting	Amplitude (mV pd)	Setting	Amplitude (mV pd)
00000	0	00111	175	01110	350
00001	25	01000	200	01111	375
00010	50	01001	225	10000	400
00011	75	01010	250	10001	425
00100	100	01011	275	10010	450
00101	125	01100	300	10011	475
00110	150	01101	325	Others	Reserved

Note:

- 1. Nominal levels. Actual levels will vary with temperature, voltage and board effects.
- 2. The maximum nominal amplitude of the output driver is 475 mV pd. Combined values of driver amplitude and de-emphasis greater than 475 mV pd should be avoided.
- 3. At higher amplitudes, actual swings will be less than the theoretical value due to process variations and environment factors, such as voltage overhead compression, package losses, board losses, and other effects.





5.1.7 DRIVE DE-EMPHASIS

The Drive De-Emphasis Level field in the PHY Parameter 1 Register (Offset 78h, bit[20:16], bit [25:21] and bit[30:26]) controls the de-emphasis base level. The settings and the corresponding values of the de-emphasis level, which can be configured globally via EEPROM or SMBUS settings.

Table 5-7 Drive De-Emphasis Base Level Register

Register	De-Emphasis Condition
C_EMP_POST_GEN1_3P5_NOM	-3.5 db
C_EMP_POST_GEN2_3P5_NOM	-3.5 db
C_EMP_POST_GEN2_6P0_NOM	-6.0 db

Table 5-8 Drive De-Emphasis Base Level Settings

Setting	De-Emphasis (mV pd)	Setting	De-Emphasis (mV pd)	Setting	De-Emphasis (mV pd)
00000	0.0	01011	69.0	10110	137.5
00001	6.0	01100	75.0	10111	144.0
00010	12.5	01101	81.0	11000	150.0
00011	19.0	01110	87.0	11001	156.0
00100	25.0	01111	94.0	11010	162.5
00101	31.0	10000	100.0	11011	169.0
00110	37.5	10001	106.0	11100	175.0
00111	44.0	10010	112.5	11101	181.0
01000	50.0	10011	119.0	11110	187.5
01001	56.0	10100	125.0	11111	194.0
01010	62.5	10101	131.0	-	-

Note

- 1. Nominal levels. Actual levels will vary with temperature, voltage and board effects.
- 2. The maximum nominal amplitude of the output driver is 475 mVpd. Combined values of driver amplitude and de-emphasis greater than 475 mVpd should be avoided.
- 3. At higher amplitudes, actual swings will be less than the theoretical value due to process variations and environment factors, such as voltage overhead compression, package losses, board losses, and other effects.

5.1.8 TRANSMITTER ELECTRICAL IDLE LATENCY

After the last character of the PCI Express transmission, the output current is reduced, and a differential voltage of less than 20 mV with common mode of VTX-CM-DC is established within 20 UI. This delay time is programmable via Transmitter PHY Latency field in the PHY Parameter 2 Register (Offset 7Ch, bit[3:0]), which can be configured by EEPROM or SMBUS settings.

5.2 DATA LINK LAYER (DLL)

The Data Link Layer (DLL) provides a reliable data transmission between two PCI Express points. An ACK/NACK protocol is employed to guarantee the integrity of the packets delivered. Each Transaction Layer Packet (TLP) is protected by a 32-bit LCRC for error detection. The DLL receiver performs LCRC calculation to determine if the incoming packet is corrupted in the serial link. If an LCRC error is found, the DLL transmitter would issue a NACK data link layer packet (DLLP) to the opposite end to request a re-transmission, otherwise an ACK DLLP would be sent out to acknowledge on reception of a good TLP.

In the transmitter, a retry buffer is implemented to store the transmitted TLPs whose corresponding ACK/NACK DLLP have not been received yet. When an ACK is received, the TLPs with sequence number equals to and smaller than that carried in the ACK would be flushed out from the buffer. If a NACK is received or no ACK/NACK is returned from the link partner after the replay timer expires, then a replay mechanism built in DLL transmitter is





triggered to re-transmit the corresponding packet that receives NACK or time-out and any other TLP transmitted after that packet.

Meanwhile, the DLL is also responsible for the initialization, updating, and monitoring of the flow-control credit. All of the flow control information is carried by DLLP to the other end of the link. Unlike TLP, DLLP is guarded by 16-bit CRC to detect if data corruption occurs.

In addition, the Media Access Control (MAC) block, which is consisted of LTSSM, multiple lanes de-skew, scrambler/de-scrambler, clock correction from inserting skip order-set, and PIPE-related control/status circuits, is implemented to interface physical layer with data link layer.

5.3 TRANSACTION LAYER RECEIVE BLOCK (TLP DECAPSULATION)

The receiving end of the transaction layer performs header information retrieval and TC/VC mapping (see section 5.5), and it validates the correctness of the transaction type and format. If the TLP is found to contain an illegal header or the indicated packet length mismatches with the actual packet length, then a Malformed TLP is reported as an error associated with the receiving port. To ensure end-to-end data integrity, a 32-bit ECRC is checked against the TLP at the receiver if the digest bit is set in header.

5.4 ROUTING

The transaction layer implements three types of routing protocols: ID-based, address-based, and implicit routing. For configuration reads, configuration writes, transaction completion, and user-defined messages, the packets are routed by their destination ID constituted of bus number, device number, and function number. Address routing is employed to forward I/O or memory transactions to the destination port, which is located within the address range indicated by the address field carried in the packet header. The packet header indicates the packet types including memory read, memory write, IO read, IO write, Message Signaling Interrupt (MSI) and user-defined message. Implicit routing is mainly used to forward system message transactions such as virtual interrupt line, power management, and so on. The message type embedded in the packet header determines the routing mechanism.

If the incoming packet cannot be forwarded to any other port due to a miss to hit the defined address range or targeted ID, this is considered as Unsupported Request (UR) packet, which is similar to a master abort event in PCI protocol.

5.5 TC/VC MAPPING

The 3-bit TC field defined in the header identifies the traffic class of the incoming packets. To enable the differential service, a TC/VC mapping table at destination port that is pre-programmed by system software or EEPROM pre-load is utilized to cast the TC labeled packets into the desired virtual channel. Note that TC0 traffic is mapped into VC0 channel by default. After the TC/VC mapping, the receive block dispatches the incoming request, completion, or data into the appropriate VC0 and VC1 queues.

5.6 QUEUE

In PCI Express, it defines six different packet types to represent request, completion, and data. They are respectively Posted Request Header (PH), Posted Request Data payload (PD), Non-Posted Request Header (NPH), Non-Posted Data Payload (NPD), Completion Header (CPLH) and Completion Data payload (CPLD). Each packet with different type would be put into a separate queue in order to facilitate the following ordering processor. Since NPD usually contains one DW, it can be merged with the corresponding NPH into a common queue named NPHD. Except NPHD, each virtual channel (VC0 or VC1) has its own corresponding packet header and data queue. When only VC0 is





needed in some applications, VC1 can be disabled and its resources assigned to VC0 by asserting VC1_EN (Virtual Channel 1 Enable) to low.

5.6.1 PH

PH queue provides TLP header spaces for posted memory writes and various message request headers. Each header space occupies sixteen bytes to accommodate 3 DW or 4 DW headers. There are two PH queues for VC0 and VC1 respectively.

5.6.2 PD

PD queue is used for storing posted request data. If the received TLP is of the posted request type and is determined to have payload coming with the header, the payload data would be put into PD queue. There are two PD queues for VC0 and VC1 respectively.

5.6.3 NPHD

NPHD queue provides TLP header spaces for non-posted request packets, which include memory read, IO read, IO write, configuration read, and configuration write. Each header space takes twenty bytes to accommodate a 3-DW header, s 4-DW header, s 3-WD header with 1-DW data, and a 4-DW header with 1-DW data. There is only one NPHD queue for VC0, since non-posted request cannot be mapped into VC1.

5.6.4 CPLH

CPLH queue provides TLP header space for completion packets. Each header space takes twelve bytes to accommodate a 3-DW header. Please note that there are no 4-DW completion headers. There are two CPLH queues for VC0 and VC1 respectively.

5.6.5 CPLD

CPLD queue is used for storing completion data. If the received TLP is of the completion type and is determined to have payload coming with the header, the payload data would be put into CPLD queue. There are two CPLD queues for VC0 and VC1 respectively.

5.7 TRANSACTION ORDERING

Within a VPPB, a set of ordering rules is defined to regulate the transactions on the PCI Express Switch including Memory, IO, Configuration and Messages, in order to avoid deadlocks and to support the Producer-Consumer model. The ordering rules defined in table 5-4 apply within a single Traffic Class (TC). There is no ordering requirement among transactions within different TC labels. Since the transactions with the same TC label are not allowed to map into different virtual channels, it implies no ordering relationship between the traffic in VC0 and VC1.

Table 5-9 Summary of PCI Express Ordering Rules

Row Pass Column	Posted	Read	Non-posted Write	Read	Non-posted Write
	Request	Request	Request	Completion	Completion
Posted Request	Yes/No1	Yes ⁵	Yes ⁵	Yes ⁵	Yes ⁵



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Read Request	No ²	Yes	Yes	Yes	Yes
Non-posted Write Request	No ²	Yes	Yes	Yes	Yes
Read Completion	Yes/No ³	Yes	Yes	Yes	Yes
Non-Posted Write	Yes ⁴	Yes	Yes	Yes	Yes
Completion					

- 1. When the Relaxed Ordering Attribute bit is cleared, the Posted Request transactions including memory write and message request must complete on the egress bus of VPPB in the order in which they are received on the ingress bus of VPPB. If the Relaxed Ordering Attribute bit is set, the Posted Request is permitted to pass over other Posted Requests occurring before it.
- 2. A Read Request transmitting in the same direction as a previously queued Posted Request transaction must push the posted write data ahead of it. The Posted Request transaction must complete on the egress bus before the Read Request can be attempted on the egress bus. The Read transaction can go to the same location as the Posted data. Therefore, if the Read transaction were to pass the Posted transaction, it would return stale data.
- 3. When the Relaxed Ordering Attribute bit is cleared, a Read completion must "pull" ahead of previously queued posted data transmitting in the same direction. In this case, the read data transmits in the same direction as the posted data, and the requestor of the read transaction is on the same side of the VPPB as the completer of the posted transaction. The posted transaction must deliver to the completer before the read data is returned to the requestor. If the Relaxed Ordering Attribute bit is set, then a read completion is permitted to pass a previously queued Memory Write or Message Request.
- 4. Non-Posted Write Completions are permitted to pass a previous Memory Write or Message Request transaction. Such transactions are actually transmitting in the opposite directions and hence have no ordering relationship.
- 5. Posted Request transactions must be given opportunities to pass Non-posted Read and Write Requests as well as Completions. Otherwise, deadlocks may occur when some older bridges, which do not support delayed transactions are mixed with PCIe Switch in the same system. A fairness algorithm is used to arbitrate between the Posted Write queue and the Non-posted transaction queue

5.8 PORT ARBITRATION

Among multiple ingress ports, the port arbitration built in the egress port determines which incoming packets to be forwarded to the output port. The arbitration algorithm contains hardware fixed Round Robin, 128-phase Weighted Round-Robin and programmable 128-phase time-based WRR. The port arbitration is held within the same VC channel. It means that each port has two port arbitration circuitries for VC0 and VC1 respectively. At the upstream ports, in addition to the inter-port packets, the intra-port packet such as configurations completion would also join the arbitration loop to get the service from Virtual Channel 0.

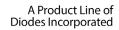
5.9 VC ARBITRATION

After port arbitration, VC arbitration is executed among different VC channels within the same source. Three arbitration algorithms are provided to choose the appropriate VC: Strict Priority, Round Robin or Weighted Round Robin

5.10 FLOW CONTROL

PCI Express employs Credit-Based Flow Control mechanism to make buffer utilization more efficient. The transaction layer transmitter ensures that it does not transmit a TLP to an opposite receiver unless the receiver has enough buffer space to accept the TLP. The transaction layer receiver has the responsibility to advertise the free buffer space to an opposite transmitter to avoid packet stale. In this Switch, each port has its own separate queues for different traffic types and the credits are sent to data link layer on the fly. The data link layer compares the current







available credits with the monitored ones and reports the updated credit to the counterpart. If no new credit is acquired, the credit reported is scheduled for every 30 us to prevent the link from entering retrain. On the other hand, the receiver at each egress port gets the usable credits from the opposite end in a link. The output port broadcasts them to all the other ingress ports to get packet transmission.

5.11 TRANSATION LAYER TRANSMIT BLOCK (TLP ENCAPSULATION)

The transmit portion of transaction layer performs the following functions. They construct the all types of forwarded TLP generated from VC arbiter, respond with the completion packets when the local resource (i.e. configuration register) is accessed, and regenerate the message that terminates at receiver to RC if acting as an upstream port.

5.12 Access Control Service

Traditionally, the packet routing between the peer-to-peer downstream ports is determined by either the address or ID field embedded in the packet header. ACS provides a mechanism for customer to selectively control access between PCI Express Endpoints attached to the downstream ports of packet switch. If ACS is enabled in the ingress port, the peer-to-peer packet forwarding will follow the rule sets of ACS rather than the destination ID or address. ACS is implemented as a set of capabilities and control registers in the associated hardware component. It brings the following benefits such as preventing the silent data corruption presented in Requests from being incorrectly routed to a peer Endpoint, validating every Request transaction between two downstream components and enabling direct routing of peer-to-peer Memory Requests whose addresses have been Translated when ATS systemis being used.



6 EEPROM INTERFACE AND SYSTEM MANAGEMENT BUS

The EEPROM interface consists of two pins: EECLK (EEPROM clock output) and EEPD (EEPROM bi-directional serial data). The Switch may control an ISSI IS24C04 or compatible parts using into 512x8 bits. The EEPROM is used to initialize a number of registers before enumeration. This is accomplished after PRST# is de-asserted, at which time the data from the EEPROM is loaded. The EEPROM interface is organized into a 16-bit base, and the Switch supplies a 7-bit EEPROM word address. The Switch does not control the EEPROM address input. It can only access the EEPROM with address input set to 0.

The System Management Bus interface consists of two pins: SMBCLK (System Management Bus Clock input) and SMBDATA (System Management Bus Data input/ output).

6.1 EEPROMINTERFACE

6.1.1 AUTO MODE EERPOM ACCESS

The Switch may access the EEPROM in a WORD format by utilizing the auto mode through a hardware sequencer. The EEPROM start-control, address, and read/write commands can be accessed through the configuration register. Before each access, the software should check the Autoload Status bit before issuing the next start.

6.1.2 EEPROM MODE AT RESET

During a reset, the Switch will automatically load the information/data from the EEPROM if the automatic load condition is met. The first offset in the EEPROM contains a signature. If the signature is recognized, the autoload initiates right after the reset.

During the autoload, the Bridge will read sequential words from the EEPROM and write to the appropriate registers. Before the Bridge registers can be accessed through the host, the autoload condition should be verified by reading bit [3] offset DCh (EEPROM Autoload Status). The host access is allowed only after the status of this bit is set to '0' which indicates that the autoload initialization sequence is complete.

6.1.3 EEPROM SPACE ADDRESS MAP

15 – 8	7 – 0	BYTE OFFSET			
EEPROM Sign	nature (1516h)	00h			
Vend	02h				
Devi	ce ID	04h			
Extended VC Count / Link Capability / Switch	Mode Operation / Interrupt pin for Port 1 ~ 2	06h			
Subsyst em	Vender ID	08h			
	tem ID	0Ah			
Max_Payload_Size Support / ASPM	Support / Role_Base Error Reporting	0Ch			
Global PHY TX Margin	Global PHY TX Margin Parameter for Port 0~2				
Global PHY Param	10h				
Global XPIP_CSR6[0] / Global	Global XPIP CSR6[0] / Global PHY Parameter 1 for Port 0~2				
Global XPIP_CSR6[4:1] / Global	PHY Parameter 2/3 for Port 0~2	14h			
Global XPIP CSR4	[15:0] for Port 0~2	16h			
Global XPIP_CSR4	[31:16] for Port 0~2	18h			
Global XPIP_CSR5	[15:0] for Port 0~2	1 Ah			
Buffer ctrl[4:0] /	1Ch				
Global XPIP_CSR6[7:5] for Port 0~2					
MAC_CTR / Global PHY	1Eh				
NFTS / Scramble / XPIP_CSR2	/ Deskew mde select for Port 0	20h			